MTM763200LBF

Panasonic

MTM763200LBF

Silicon N-channel MOSFET (FET1) Silicon P-channel MOSFET (FET2)

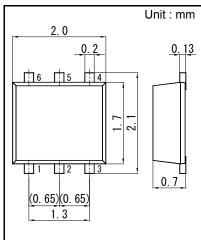
For Switching For DC-DC Converter

■ Features

- Low Drain-source On-state Resistance : RDS(on)typ. N-ch = 80 mΩ(VGS = 4.0 V) P-ch:100 mΩ (VGS = -4.0 V)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL : Level 1 compliant)
- Marking Symbol JB
- Basic Part Number Nch+Pch MOS 20V (Individual)

■ Packaging

Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)



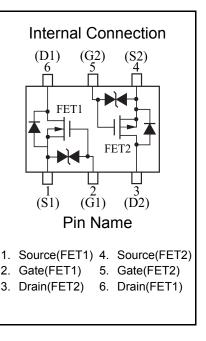
- 1. Source(FET1) 4. Source(FET2)
- 2. Gate(FET1) 5. Gate(FET2)
- 3. Drain(FET2) 6. Drain(FET1)

Panasonic	WSMini6-F1-B
JEITA	SC-113DA
Code	_

■ Absolute Maximum Ratings Ta = 25 °C

	Parameter	Symbol	Rating	Unit
	Drain-source Voltage	VDS	20	V
	Gate-source Voltage	VGS	±10	V
	Drain current	ID	1.9	Α
	Peak drain current	IDp	12	Α
	Drain-source Voltage	VDS	-20	V
	Gate-source Voltage	VGS	±10	V
	Drain current	ID	-1.2	Α
	Peak drain current	IDp	-7	Α
	Total power dissipation *1	PD	700	mW
Overall	Channel temperature	Tch	150	°C
	Operating ambient temperature	Topr	-40 to +85	°C
	Storage Temperature Range	Tstg	-55 to +150	°C

Note *1 Measuring on ceramic substrate at 40 mm \cdot 38 mm \cdot 0.2 mm. PD absolute maximum rating Non-heat sink: 150 mW.



Revision. 2

MOS FET

ns

MTM763200LBF

12

50

Panasonic

■ Electrical Characteristics Ta = 25 °C ± 3 °C

FET1 (N-ch.)						
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = 1.0 mA, VGS = 0 V	20			V
Zero Gate Voltage Drain Current	IDSS	VDS = 20 V, VGS = 0 V			1.0	μA
Gate-source Leakage Current	IGSS	$VGS = \pm 8.0 \text{ V}, VDS = 0 \text{ V}$			±10	μΑ
Gate-source Threshold Voltage	Vth	ID = 1.0 mA, VDS = 10 V	0.4	0.85	1.3	V
Drain-source ON resistance *1	RDS(ON)1	ID = 1.0 A, VGS = 4.0 V		80	105	mΩ
Drain-source ON resistance	RDS(ON)2	ID = 0.5 A, VGS = 2.5 V		100	150	
Forward transfer admittance *1	Yfs	ID = 1.0 A, VDS = 10 V	3.0			S
Input Capacitance	Ciss			280		
Output Capacitance	Coss	VDS = 10 V, VGS = 0, f = 1 MHz		18		pF
Reverse Transfer Capacitance	Crss			17		
Turn on time *2	ton	VDD = 10 V, VGS = 0 to 4 V,		12		

ID = 1.0 A

ID = 1.0 A

VDD = 10 V, VGS = 4 to 0 V,

Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

ton

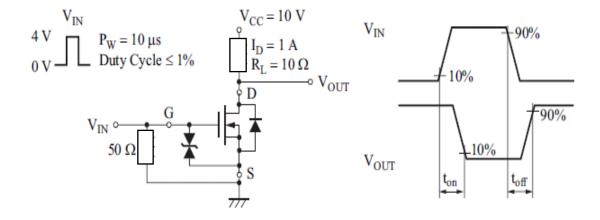
toff

2. *1 Pulse measurement

Turn-on time *2

Turn-off time *2

*2 Measurement circuit for Turn-on Time / Turn-off Time



Doc No. TT4-EA-10567

Panasonic

Revision. 2

MOS FET

MTM763200LBF

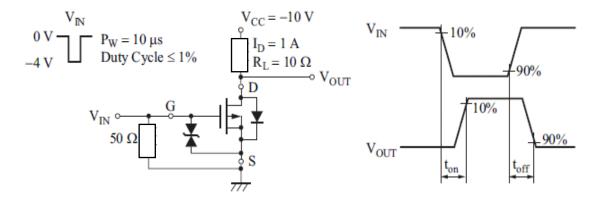
FET2 (P-ch.)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = -1 mA, VGS = 0 V	-20			V
Zero Gate Voltage Drain Current	IDSS	VDS = -20 V, VGS = 0 V			-1.0	μA
Gate-source Leakage Current	IGSS	$VGS = \pm 8 \text{ V}, VDS = 0 \text{ V}$			±10	μA
Gate-source Threshold Voltage	Vth	ID = -1.0 mA, VDS = -10 V	-0.4	-0.85	-1.3	V
Drain-source On-state Resistance *1	RDS(ON)1	ID = -1.0 A, VGS = -4.0 V		100	130	m()
	RDS(ON)2	ID = -0.6 A, VGS = -2.5 V		130	200	mΩ
Forward transfer admittance *1	Yfs	ID = -1.0 A, VDS = -10 V	3.0			S
Input Capacitance	Ciss			440		
Output Capacitance	Coss	VDS = -10 V, VGS = 0, f = 1 MHz		40		pF
Reverse Transfer Capacitance	Crss			38		
Turn-on Time *2	ton	VDD = -10 V, VGS = 0 to -4 V		35		,
rum-on rime		ID = -1 A		33		ns
Turn-off Time *2	toff	VDD = -10 V, VGS = -4 to 0 V		100		
rum-on rime		ID = -1 A		100		

Note: 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

2. *1 Pulse measurement

*2 Measurement circuit for Turn-on Time / Turn-off Time



MTM763200LBF

Panasonic

Technical Data (reference) FET1(Nch.) ID - VDS ID - VGS 1.5 1.5 VGS = 4.0 V Drain Current ID (A) Drain current ID (A) 9.0 2.0 V Ta = 85 °C 25 ℃ 1.5 V - 40 °C 0 0 0.1 0.2 0.3 0 0.5 2 1.5 Drain-source Voltage VDS (V) Gate-source voltage VGS (V) VDS - VGS RDS(on) - ID 1000 0.6 Drain-source On-state Resistance RDS(on) (mΩ) Drain-source Voltage VDS (V) 0.5 0.4 0.5 A 2.5 V 0.3 ID = 1.0 A VGS = 4.0 V 0.2 0.1 0 10 2 0 3 0.1 6 Drain Current ID (A) Gate-source Voltage VGS (V) Capacitance - VDS 1000 Ciss

Capacitance - VDS

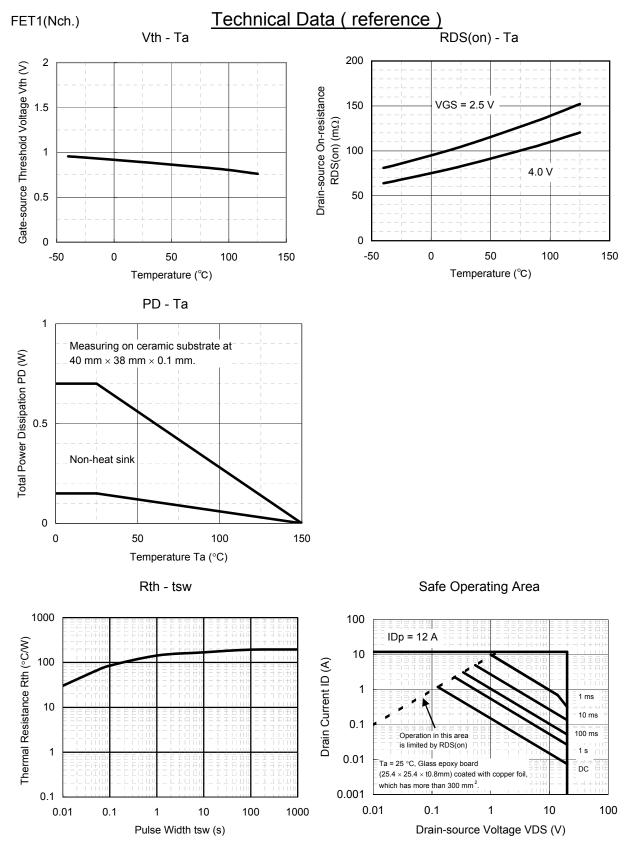
1000

(La)

Output

MTM763200LBF

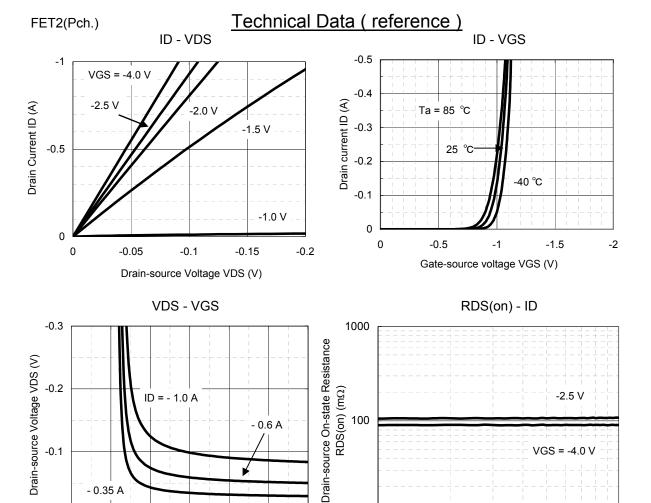
Panasonic



Page 5 of 8

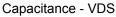
MTM763200LBF

Panasonic



10

-0.1



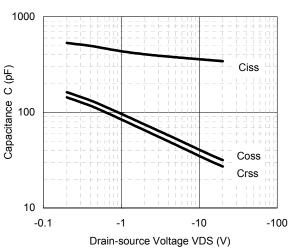
Gate-source Voltage VGS (V)

-3

-4

-5

-6



-1

Drain Current ID (A)

Established: 2008-03-07 Revised: 2013-10-17

0

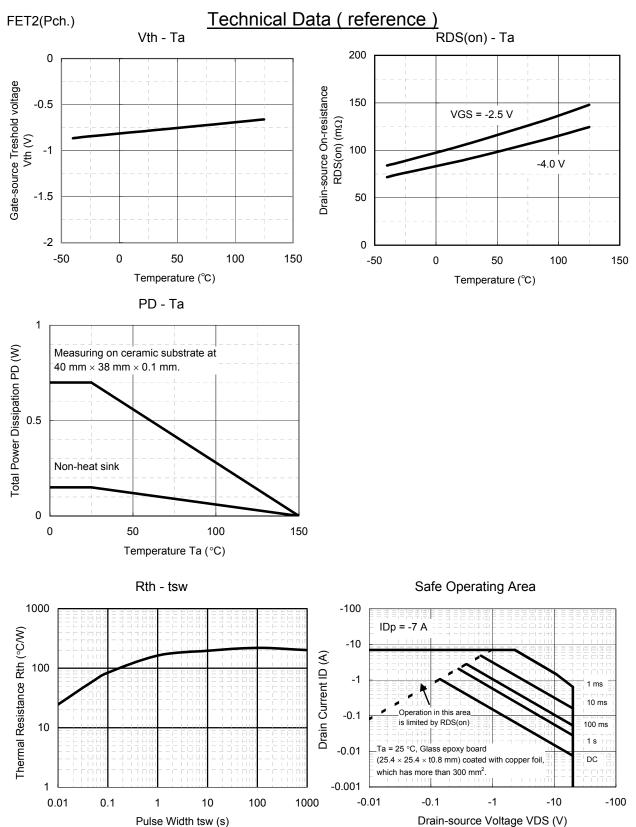
0

-1

-2

MTM763200LBF





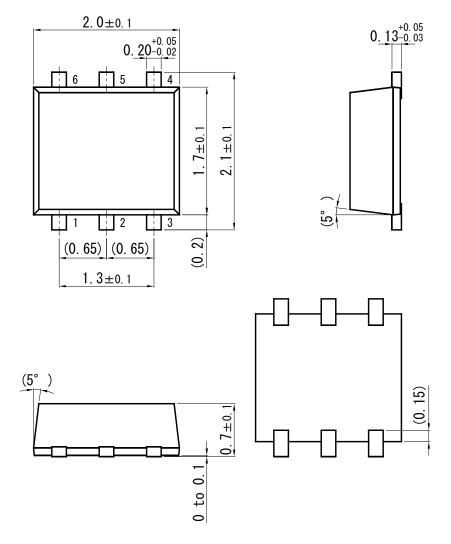
Page 7 of 8

MTM763200LBF

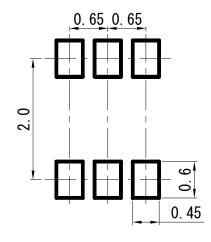
WSMini6-F1-B

Panasonic

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



Request for your special attention and precautions in using the technical information and semiconductors described in this book

- (1) If any of the products or technical information described in this book is to be exported or provided to non-residents, the laws and regulations of the exporting country, especially, those with regard to security export control, must be observed.
- (2) The technical information described in this book is intended only to show the main characteristics and application circuit examples of the products. No license is granted in and to any intellectual property right or other right owned by Panasonic Corporation or any other company. Therefore, no responsibility is assumed by our company as to the infringement upon any such right owned by any other company which may arise as a result of the use of technical information described in this book.
- (3) The products described in this book are intended to be used for general applications (such as office equipment, communications equipment, measuring instruments and household appliances), or for specific applications as expressly stated in this book.

 Consult our sales staff in advance for information on the following applications:
 - Special applications (such as for airplanes, aerospace, automotive equipment, traffic signaling equipment, combustion equipment, life support systems and safety devices) in which exceptional quality and reliability are required, or if the failure or malfunction of the products may directly jeopardize life or harm the human body.
 - It is to be understood that our company shall not be held responsible for any damage incurred as a result of or in connection with your using the products described in this book for any special application, unless our company agrees to your using the products in this book for any special application.
- (4) The products and product specifications described in this book are subject to change without notice for modification and/or improvement. At the final stage of your design, purchasing, or use of the products, therefore, ask for the most up-to-date Product Standards in advance to make sure that the latest specifications satisfy your requirements.
- (5) When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode-switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.
 - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- (6) Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- (7) This book may be not reprinted or reproduced whether wholly or partially, without the prior written permission of our company.

20100202